

**RoHS** COMPLIANT

Vishay Siliconix

## N-Channel 150-V (D-S) MOSFET

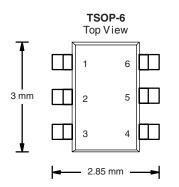
| PRODUCT SUMMARY     |                                  |                    |  |  |
|---------------------|----------------------------------|--------------------|--|--|
| V <sub>DS</sub> (V) | R <sub>DS(on)</sub> (Ω)          | I <sub>D</sub> (A) |  |  |
| 150                 | 0.375 at V <sub>GS</sub> = 10 V  | 1.5                |  |  |
|                     | 0.400 at V <sub>GS</sub> = 6.0 V | 1.4                |  |  |

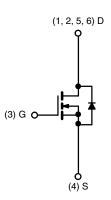
#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- PWM Optimized for Fast Switching In Small Footprint
- 100 % Rg Tested

#### APPLICATIONS

Primary Side Switch for Low Power DC/DC Converters





Ordering Information: Si3440DV-T1-E3 (Lead (Pb)-free)

N-Channel MOSFET

| <b>ABSOLUTE MAXIMUM RATINGS</b> T                               | A = 25 °C, unle        | ss otherwise ı                    | noted       |              |      |
|---|------------------------|-----------------------------------|-------------|--------------|------|
| Parameter   |                        | Symbol                            | 5 s         | Steady State | Unit |
| Drain-Source Voltage  |                        | V <sub>DS</sub>                   | 150         |              | V    |
| Gate-Source Voltage   |                        | V <sub>GS</sub>                   | ± 20        |              |      |
| Continuous Drain Current /T 175 °C\a                            | T <sub>A</sub> = 25 °C | – I <sub>D</sub>                  | 1.5         | 1.2          |      |
| Continuous Drain Current (T <sub>J</sub> = 175 °C) <sup>a</sup> | T <sub>A</sub> = 85 °C |                                   | 1.1         | 0.8          | ^    |
| Pulsed Drain Current  |                        | I <sub>DM</sub>                   | 6           |              | A    |
| Single Avalanche Current  | L = 0.1 mH             | I <sub>AS</sub>                   | 4           |              |      |
| Single Avalanche Energy (Duty Cycle $\leq$ 1 %)                 |                        | E <sub>AS</sub>                   | 0.8         |              | mJ   |
| Continuous Source Current (Diode Conduction) <sup>a</sup>       |                        | ۱ <sub>S</sub>                    | 1.7         | 1.7 1.0      |      |
| Maximum Power Dissipation <sup>a</sup>                          | T <sub>A</sub> = 25 °C | PD                                | 2.0         | 1.14         | W    |
|   | T <sub>A</sub> = 85 °C | 1 'D                              | 1.0         | 0.59         | vv   |
| Operating Junction and Storage Temperature Range                |                        | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150 |              | °C   |

| THERMAL RESISTANCE RATINGS               |              |                     |         |         |      |
|--|--------------|---------------------|---------|---------|------|
| Parameter                                |              | Symbol              | Typical | Maximum | Unit |
| Manimum has the Anthia ta                | t ≤ 5 s      | - R <sub>thJA</sub> | 45      | 62.5    | °C/W |
| Maximum Junction-to-Ambient <sup>a</sup> | Steady State |                     | 90      | 110     |      |
| Maximum Junction-to-Foot (Drain)         | Steady State | R <sub>thJF</sub>   | 25      | 30      |      |

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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| <b>SPECIFICATIONS</b> $T_J = 25 \circ 0$      | C, unless o         | otherwise noted  |                                   |       |       |      |  |
|---|---------------------|--|-----------------------------------|-------|-------|------|--|
| Parameter                                     | Symbol              | Test Conditions  | Min. Typ.                         |       | Max.  | Unit |  |
| Static  |                     |  |                                   |       |       |      |  |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub> | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$   | 2                                 |       | 4     | V    |  |
| Gate-Body Leakage                             | I <sub>GSS</sub>    | $V_{DS} = 0 V, V_{GS} = \pm 20 V$  | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ |       | ± 100 | nA   |  |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>    | V <sub>DS</sub> = 150 V, V <sub>GS</sub> = 0 V   |                                   |       | 1     |      |  |
|   |                     | $V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$  |                                   |       | 5     | μΑ   |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>  | $V_{DS} \ge 5$ V, $V_{GS}$ = 10 V  | 4                                 |       |       | А    |  |
| Drain-Source On-State Resistance <sup>a</sup> | D                   | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.5 A   |                                   | 0.310 | 0.375 | 0    |  |
|   | R <sub>DS(on)</sub> | $V_{GS} = 6.0 \text{ V}, \text{ I}_{D} = 1.4 \text{ A}$  |                                   | 0.330 | 0.400 | Ω    |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>     | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 1.5 A   |                                   | 4.1   |       | S    |  |
| Diode Forward Voltage <sup>a</sup>            | V <sub>SD</sub>     | $I_{\rm S} = 1.7$ A, $V_{\rm GS} = 0$ V  |                                   | 0.8   | 1.2   | V    |  |
| Dynamic <sup>b</sup>                          |                     |  |                                   |       |       |      |  |
| Total Gate Charge                             | Qg                  |  |                                   | 5.4   | 8     |      |  |
| Gate-Source Charge                            | Q <sub>gs</sub>     | $V_{DS}$ = 75 V, $V_{GS}$ = 10 V, $I_{D}$ = 1.5 A  |                                   | 1.1   |       | nC   |  |
| Gate-Drain Charge                             | Q <sub>gd</sub>     |  |                                   | 1.9   |       | 1    |  |
| Gate Resistance                               | R <sub>g</sub>      | f = 1 MHz  | 4                                 | 9     | 15    | Ω    |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>  |  |                                   | 8     | 15    |      |  |
| Rise Time                                     | t <sub>r</sub>      | $V_{DD}$ = 75 V, $R_L$ = 75 $\Omega$   |                                   | 10    | 15    | ns   |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub> | $\textbf{I}_{\text{D}}\cong \textbf{1} \text{ A}, \text{ V}_{\text{GEN}} = \textbf{10} \text{ V}, \text{ R}_{\text{G}} = \textbf{6} \ \boldsymbol{\Omega}$ |                                   | 20    | 30    |      |  |
| Fall Time                                     | t <sub>f</sub>      |  |                                   | 15    | 25    |      |  |
| Source-Drain Reverse Recovery Time            | t <sub>rr</sub>     | $I_F = 1.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$   |                                   | 40    | 60    |      |  |

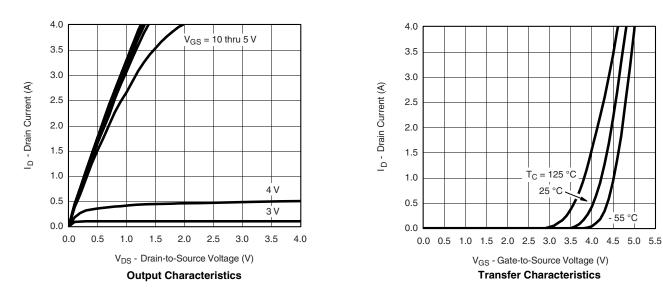
Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

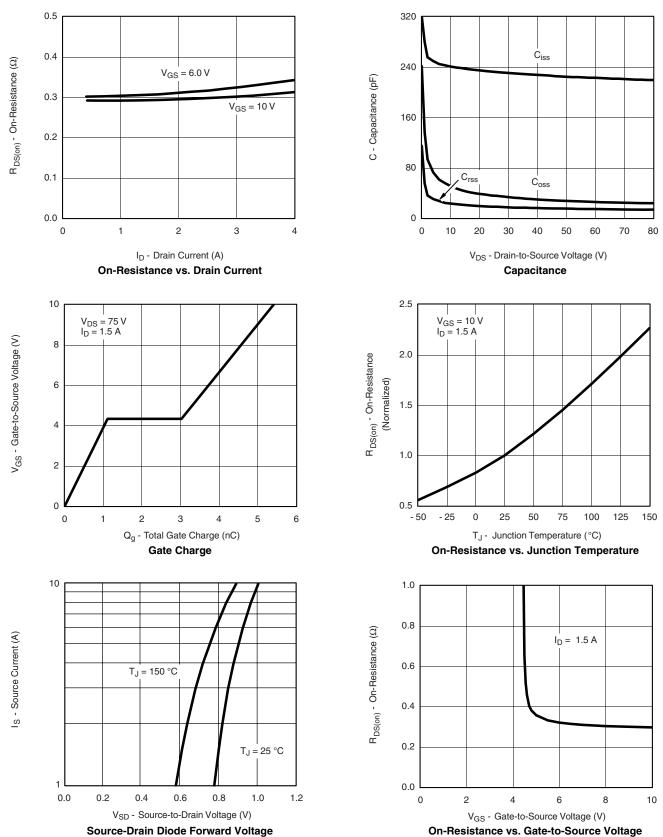




# Si3440DV

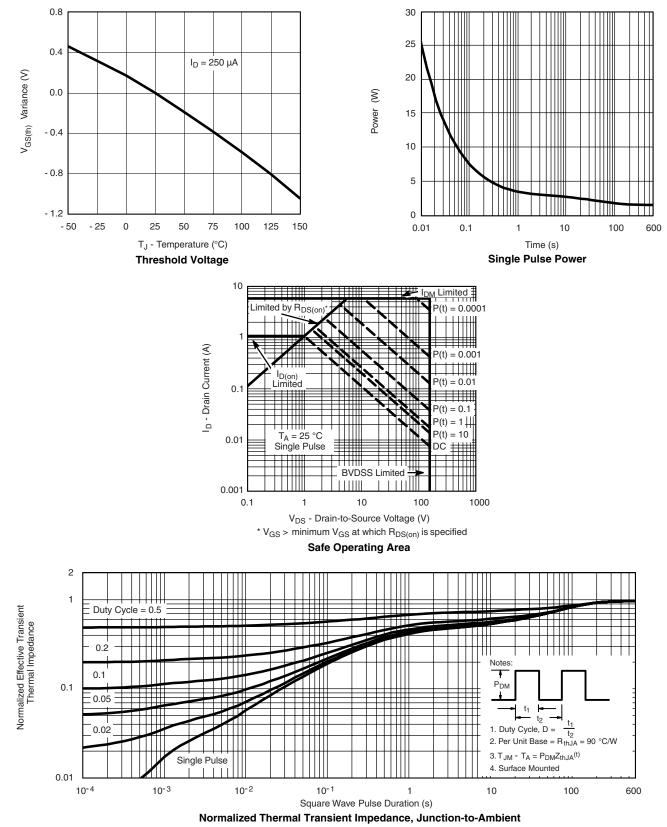
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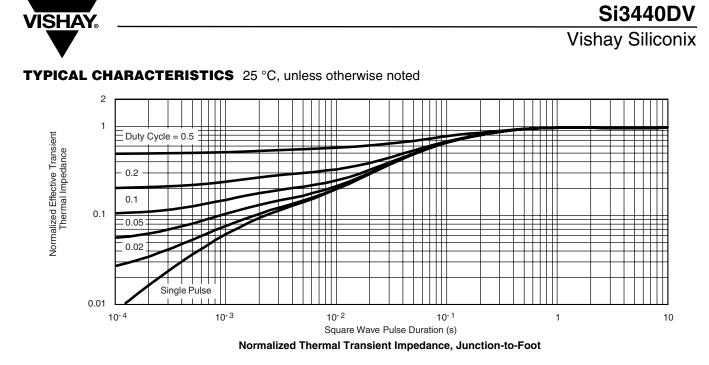


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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72380.



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